



Pb-free
HEAT



1201W Series

Bi-color Type (3.0 X 2.5 mm)

Features

Package	Bi-color Type (3.0 X 2.5 mm), Milky White resin
Product features	• Outer Dimension 3.0 x 2.5 x 1.4mm (L x W x H) • Temperature range - Storage Temperature : -40℃~100℃ - Operating Temperature : -30℃~85℃ • Lead-free soldering compatible • RoHS compliant
Dominant wavelength	Green : 558nm(BG),567nm(PG) Yellow Green : 572nm(PY) Red : 647nm(BR)
Half Intensity Angle	BG,PG,PY : $\theta_x = 156 \text{ deg.}$, $\theta_y = 149 \text{ deg.}$ BR : $\theta_x = 160 \text{ deg.}$, $\theta_y = 150 \text{ deg.}$
Die materials	BG,PG,PY : GaP, BR : GaAlAs
Assembly method	Auto pick & place machine (Auto Mounter)
Soldering methods	Reflow soldering and manual soldering
Taping and reel	2,500pcs per reel in a 8mm width tape. (Standard) Reel diameter: $\phi 180\text{mm}$
ESD	More than 2kV (HBM)

Recommended Applications

Communication Machine, Electric Household Appliances, OA/FA, Other General Applications



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Color and Luminous Intensity

(Ta=25°C)

Part No.	Die Name	Material	Emitted Color	Lens Color	Dominant Wavelength λ_d (nm)		Luminous Intensity I_v (mcd)		
					TYP.	I_F	MIN.	TYP.	I_F
BRBG1201W	BG	GaP	Green	Water Clear	558	20	0.7	2	20
	BR	GaAlAs	Red		647	20	1.6	12.8	20
BRPG1201W	PG	GaP	Green	Water Clear	567	20	1.2	4.8	20
	BR	GaAlAs	Red		647	20	1.6	12.8	20
BRPY1201W	PY	GaP	Yellow Green	Water Clear	572	20	1.4	8	20
	BR	GaAlAs	Red		647	20	1.6	12.8	20

Absolute Maximum Ratings

(Ta=25°C)

Item	Symbol	Absolute Maximum Ratings				Unit
		BG	PG	PY	BR	
Power Dissipation	P_d	75	75	75	75	mW
Forward Current	I_F	30	30	30	30	mA
Pulse Forward Current ※1	I_{FRM}	70	70	70	70	mA
Derating (Ta=25°C or higher)	ΔI_F	0.42	0.42	0.42	0.42	mA/°C
	ΔI_{FRM}	0.93	0.93	0.93	0.93	mA/°C
Reverse Voltage	V_R	4	4	4	4	V
Operating Temperature	T_{opr}	-30~+85				°C
Storage Temperature	T_{stg}	-40~+100				°C

※1 I_{FRM} Measurement condition : Pulse Width $\leq 1ms.$, Duty $\leq 1/20$.

※ The ratings specified above are under the condition that only one diode is lit.
50% Max. of each rating shall be applied when two diodes are lit simultaneously.



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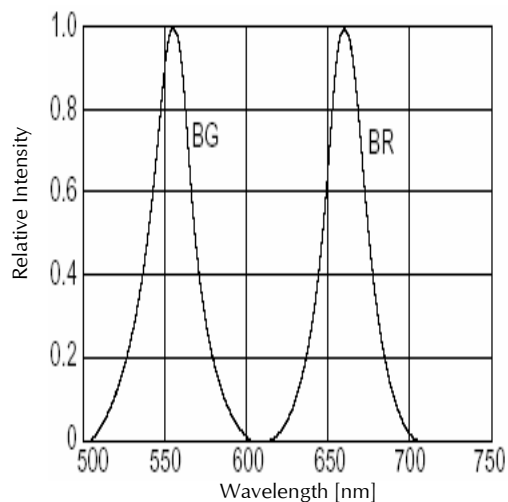
Electro-Optical Characteristics

(Ta=25°C)

Item		Symbol	Characteristics					Unit
	Conditions			BG	PG	PY	BR	
Forward Voltage	I _F =20mA	V _F	TYP.	2.1	2.1	2.1	1.7	V
			MAX.	2.5	2.5	2.5	2.0	
Reverse Current	V _R =4V	I _R	MAX.	100	100	100	100	μ A
Peak Wavelength	I _F =20mA	λ _p	TYP.	555	560	570	660	nm
Dominant Wavelength	I _F =20mA	λ _d	TYP.	558	567	572	647	nm
Spectral Line Half Width	I _F =20mA	Δ λ	TYP.	30	30	30	30	nm
Half Intensity Angle	I _F =20mA	2 θ 1/2	TYP.	156(θ x)	156(θ x)	156(θ x)	160(θ x)	deg.
				149(θ y)	149(θ y)	149(θ y)	150(θ y)	

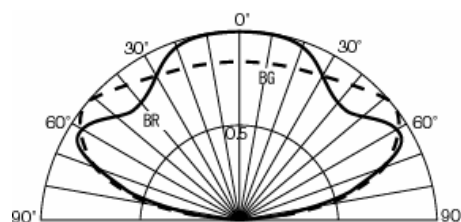
Technical Data(BRBG)

Spectral Distribution
Relative Intensity vs. Wavelength
Condition : $T_a = 25^\circ\text{C}$, $I_F = 20\text{mA}$

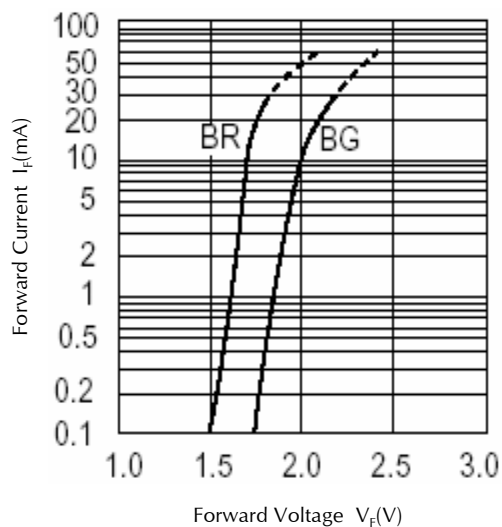


Spatial Distribution Example

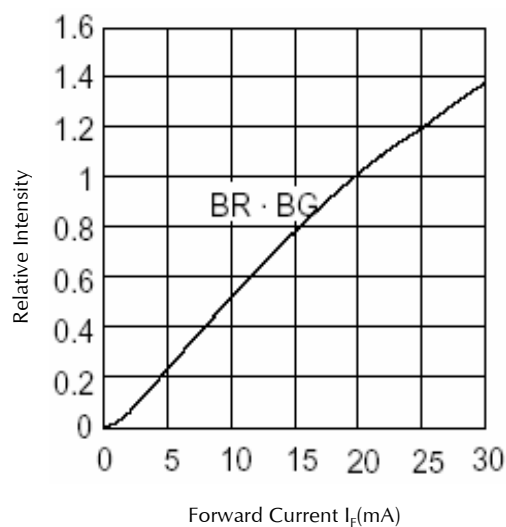
Condition : $T_a = 25^\circ\text{C}$



Forward Voltage vs. Forward Current
Condition : $T_a = 25^\circ\text{C}$



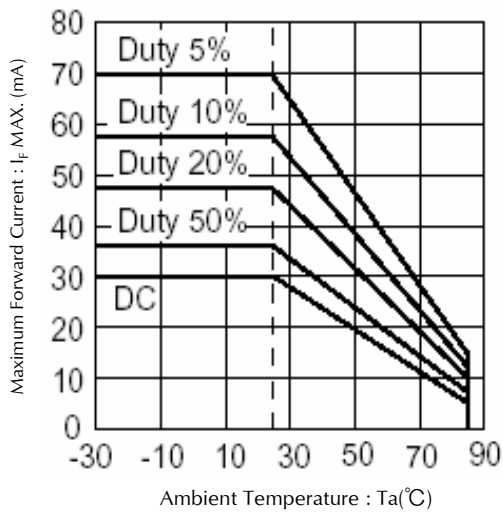
Forward Current vs. Relative Intensity
Condition : $T_a = 25^\circ\text{C}$



Technical Data(BRBG)

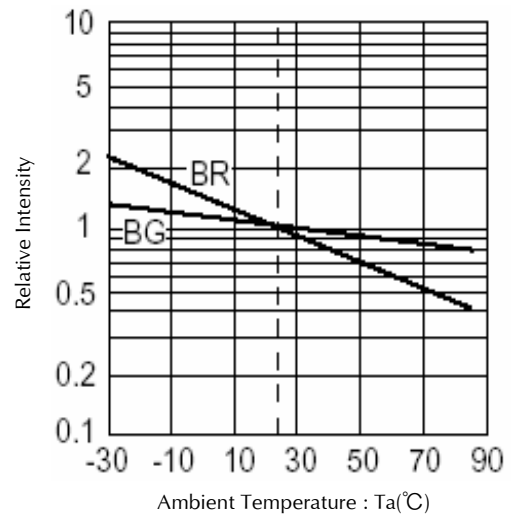
Derating

Ambient Temperature vs. Maximum Forward Current
Repetition Frequency : $f \geq 50\text{Hz}$

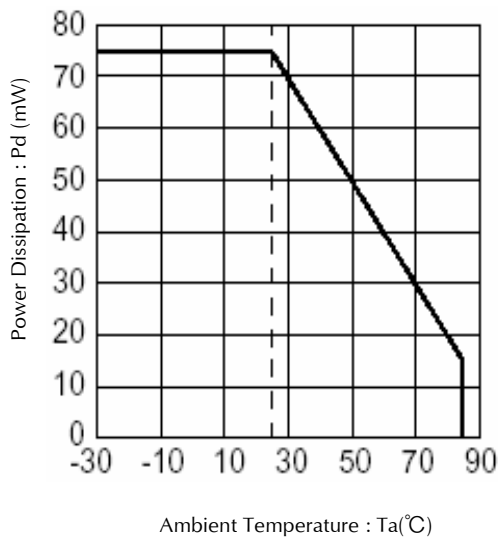


Ambient Temperature vs. Relative Intensity

Condition : $I_F = 20\text{mA}$

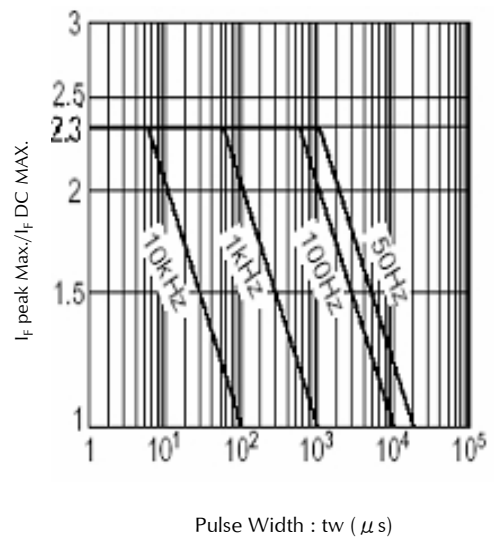


Power Dissipation vs. Ambient Temperature



Pulse Width vs. Maximum Tolerable Peak Current

Condition : $T_a = 25^{\circ}\text{C}$

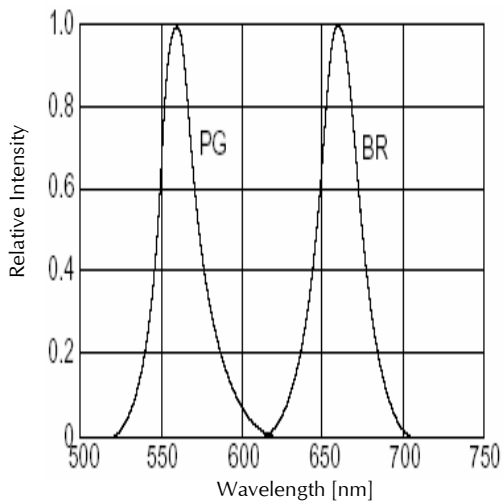


Technical Data(BRPG)

Spectral Distribution

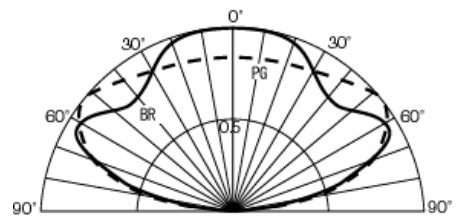
Relative Intensity vs. Wavelength

Condition : $T_a = 25^\circ\text{C}$, $I_F = 20\text{mA}$



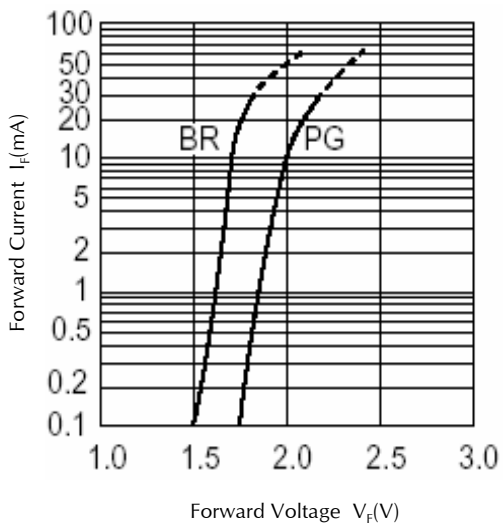
Spatial Distribution Example

Condition : $T_a = 25^\circ\text{C}$



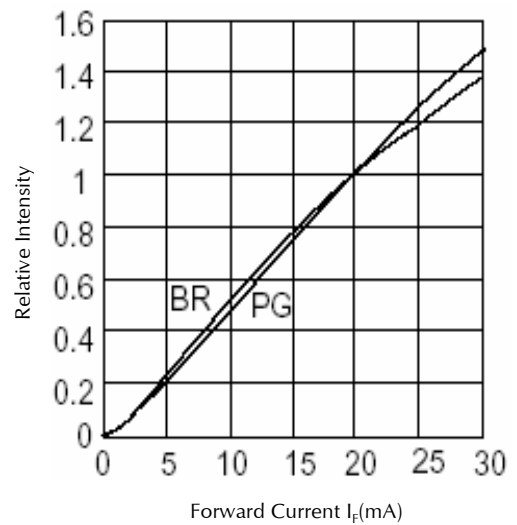
Forward Voltage vs. Forward Current

Condition : $T_a = 25^\circ\text{C}$



Forward Current vs. Relative Intensity

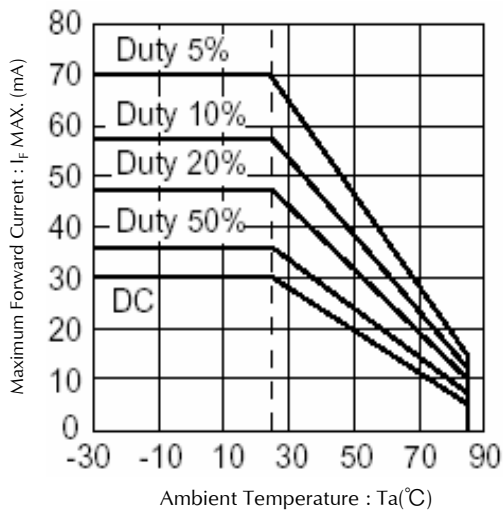
Condition : $T_a = 25^\circ\text{C}$



Technical Data(BRPG)

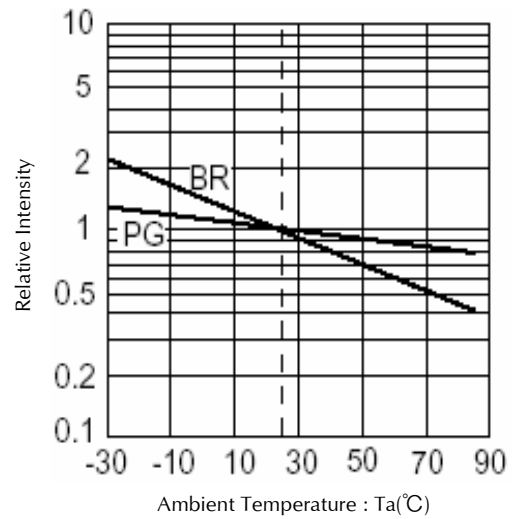
Derating

Ambient Temperature vs. Maximum Forward Current
Repetition Frequency : $f \geq 50\text{Hz}$

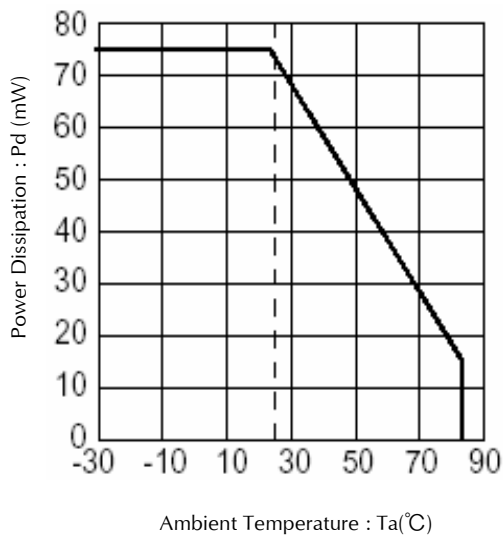


Ambient Temperature vs. Relative Intensity

Condition : $I_F = 20\text{mA}$

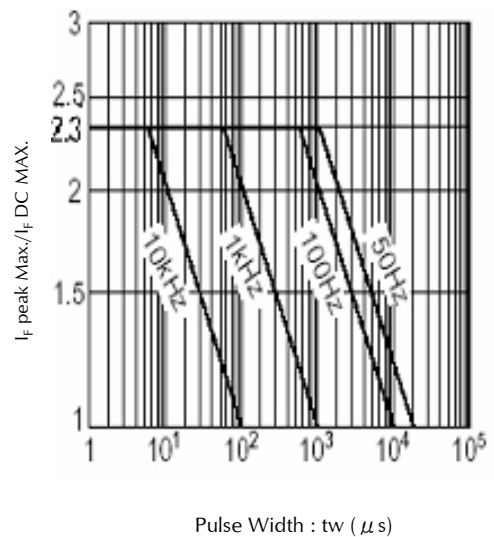


Power Dissipation vs. Ambient Temperature



Pulse Width vs. Maximum Tolerable Peak Current

Condition : $T_a = 25^{\circ}\text{C}$

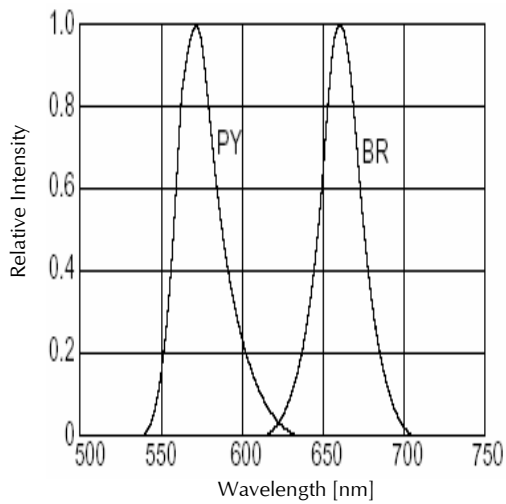


Technical Data(BRPY)

Spectral Distribution

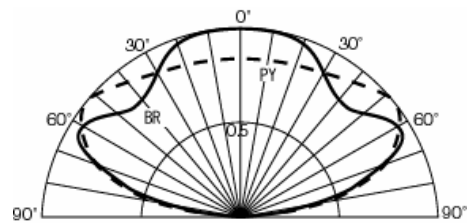
Relative Intensity vs. Wavelength

Condition : $T_a = 25^\circ\text{C}$, $I_F = 20\text{mA}$



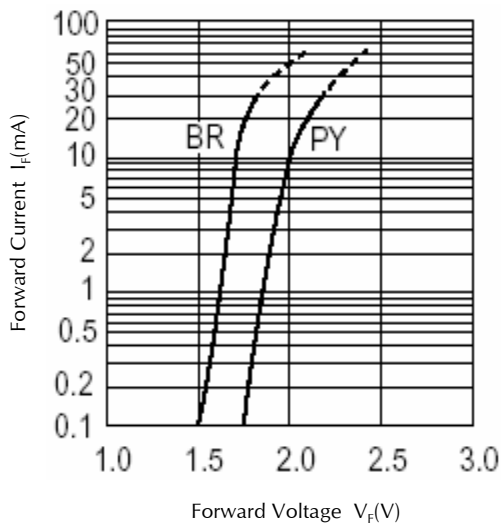
Spatial Distribution Example

Condition : $T_a = 25^\circ\text{C}$



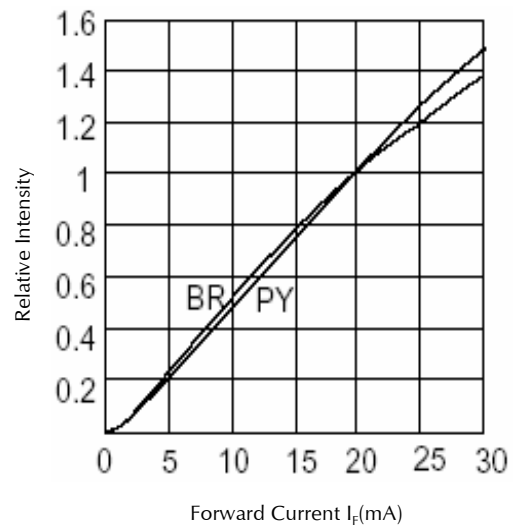
Forward Voltage vs. Forward Current

Condition : $T_a = 25^\circ\text{C}$



Forward Current vs. Relative Intensity

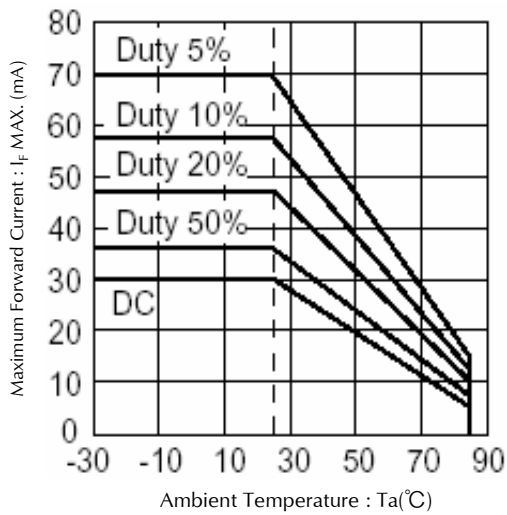
Condition : $T_a = 25^\circ\text{C}$



Technical Data(BRPY)

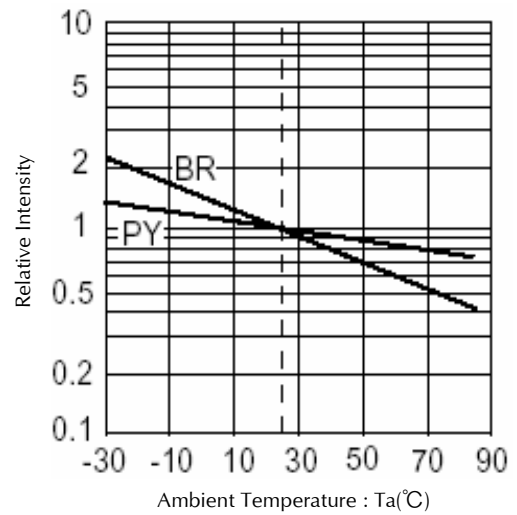
Derating

Ambient Temperature vs. Maximum Forward Current
Repetition Frequency : $f \geq 50\text{Hz}$

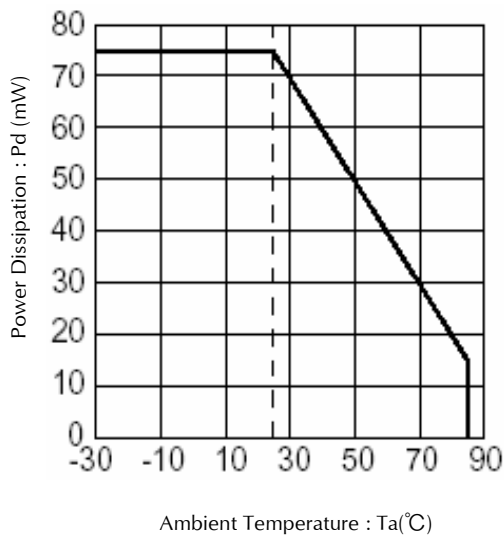


Ambient Temperature vs. Relative Intensity

Condition : $I_F = 20\text{mA}$

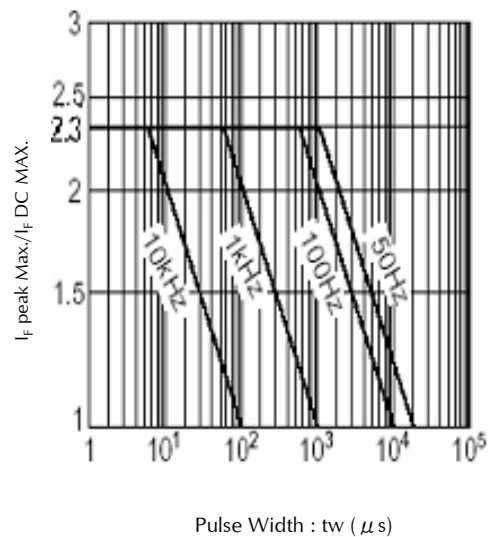


Power Dissipation vs. Ambient Temperature



Pulse Width vs. Maximum Tolerable Peak Current

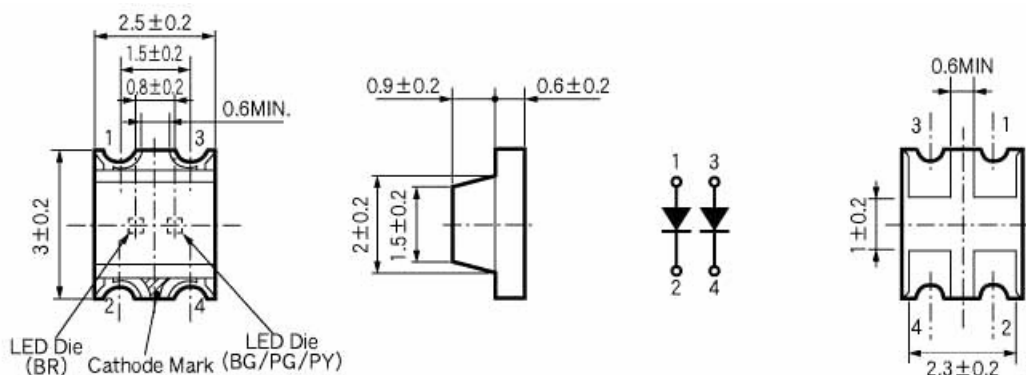
Condition : $T_a = 25^{\circ}\text{C}$



Package Dimensions

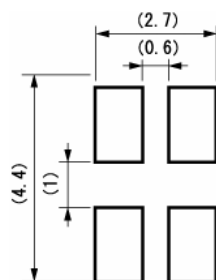
(Unit: mm)

Weight: (13.0)mg



Recommended Soldering Pattern

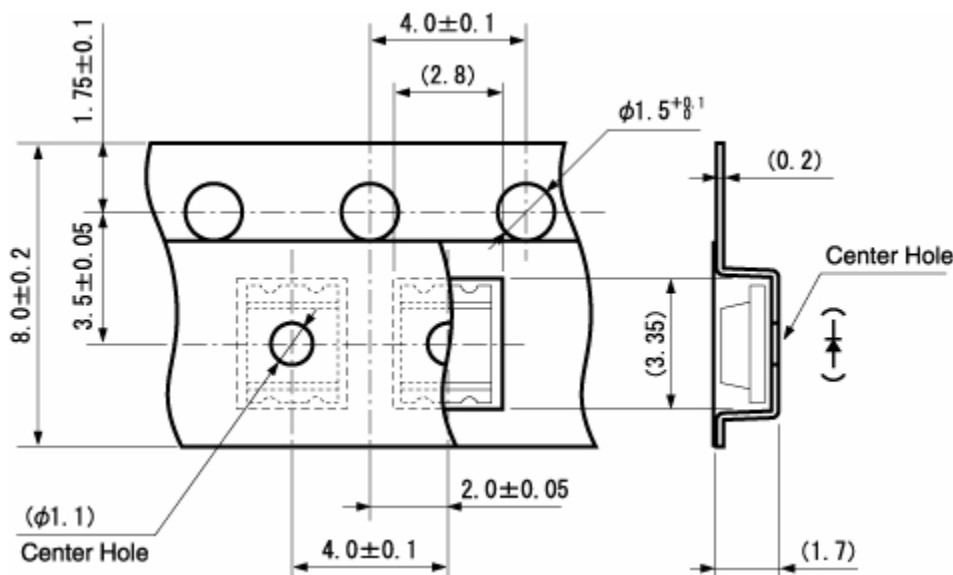
(Unit: mm)



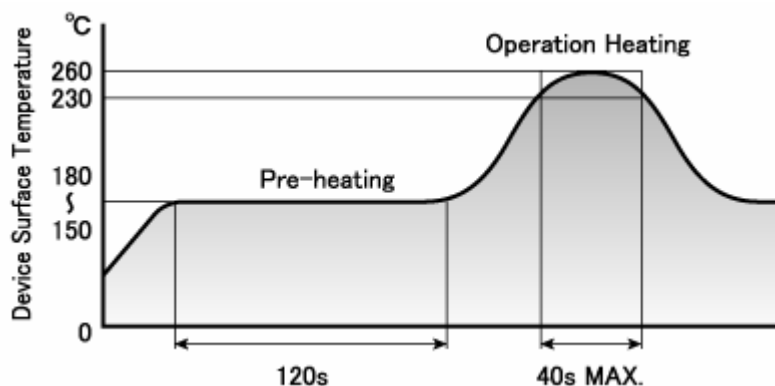
Taping Specification

(Unit: mm)

Quantity : 2,500pcs/ reel (standard)



Reflow Soldering Conditions



- 1) The above profile temperature gives the maximum temperature of the LED resin surface. Please set the temperature so as to avoid exceeding this range.
- 2) Total times of reflow soldering process shall be no more than 2 times. When the second reflow soldering process is performed, intervals between the first and second reflow should be short as possible (while allowing some time for the component to return to normal temperature after the first reflow) in order to prevent the LED from absorbing moisture.
- 3) Temperature fluctuation to the LED during the pre-heating process shall be minimized.

Manual Soldering Conditions

Iron tip temp. 350 °C (MAX.)

Soldering time and frequency 3 s (MAX.)
1 time (MAX.)

Reliability Testing Result

Reliability Testing Result	Applicable Standard	Testing Conditions	Duration	Failure
Room Temp. Operating Life	EIAJ ED-4701/100(101)	Ta = 25°C, If = Maximum Rated Current	1,000 h	0/25
Resistance to Soldering Heat	EIAJ ED-4701/300(301)	Pre-heating : 150~180°C 120s Max. Operation Heating : 230°C 40s Max. Peak Temperature : 260°C	Twice	0/25
Temperature Cycling	EIAJ ED-4701/100(105)	Minimum Rated Storage Temperature(30min) ~ Normal Temperature(15min) ~ Maximum Rated Storage Temperature(30min) ~ Normal Temperature(15min)	5 cycles	0/25
Wet High Temp. Storage Life	EIAJ ED-4701/100(103)	Ta = 60±2°C, RH = 90±5%	1,000 h	0/25
High Temp. Storage Life	EIAJ ED-4701/200(201)	Ta = Maximum Rated Storage Temperature	1,000 h	0/25
Low Temp. Storage Life	EIAJ ED-4701/200(202)	Ta = Minimum Rated Storage Temperature	1,000 h	0/25
Vibration, Variable Frequency	EIAJ ED-4701/400(403)	98.1m/s ² (10G), 100 ~ 2KHz sweep for 20min., XYZ each direction	2 h	0/10

Failure Criteria

Items	Symbols	Conditions	Failure criteria
Luminous Intensity	Iv	If Value of each product Luminous Intensity	Testing Min. Value < Spec. Min. Value x 0.5
Forward Voltage	V _F	If Value of each product Forward Voltage	Testing Max. Value ≥ Spec. Max. Value x 1.2
Reverse Current	I _R	V _R = Maximum Rated Reverse Voltage V	Testing Max. Value ≥ Spec. Max. Value x 2.5
Cosmetic Appearance	-	-	Occurrence of notable decoloration, deformation and cracking

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